



N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low R_{DS(ON)}
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability
- "Green" Device (Note 2)

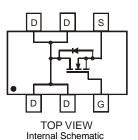
Mechanical Data

- Case: SOT-26 •
- Case Material Molded Plastic. UL Flammability Rating 94V-0 •
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 2
- Ordering Information: See page 2 •
- Weight: 0.008 grams (approximate) •

SOT-26



TOP VIEW



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Maximum Ratings	$@T_A = 25^{\circ}C$ unless otherwise specified	

Characteri	stic		Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 3)	Steady State	T _A = 25°C T _A = 70°C		5.3 4.2	А
Pulsed Drain Current (Note 4)			IDM	31	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 3)	PD	1.12	W
Thermal Resistance, Junction to Ambient $T_A = 25^{\circ}C$ (Note 3)	$R_{ heta JA}$	111	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	۵°

Notes: 1. No purposefully added lead.

Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
Device mounted on FR-4 PCB, with minimum recommended pad layout.

4. Repetitive Rating, pulse width limited by junction temperature.

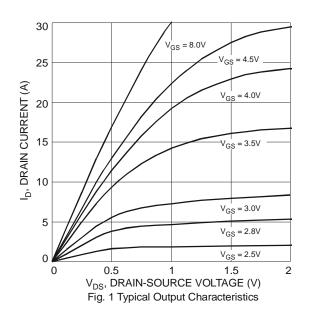


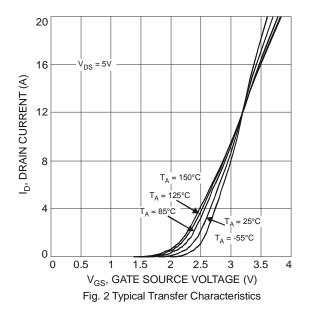
Electrical Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(th)}	1.0	1.5	2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		-	22 32	27 40	mΩ	$V_{GS} = 10V, I_D = 7A$	
Static Drain-Source On-Resistance	R _{DS} (ON)					$V_{GS} = 4.5V, I_D = 5.6A$	
Forward Transfer Admittance	Y _{fs}	-	10	-	S	$V_{DS} = 5V, I_D = 7A$	
Diode Forward Voltage	V _{SD}	-	0.75	1.0	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 6)			-				
Input Capacitance	Ciss	-	404	-	pF		
Output Capacitance	Coss	-	52	-	pF	V _{DS} =15V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	45	-	pF	1 = 1.000112	
Gate Resistance	Rg	-	1.51	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	-	9.2	-	nC		
Gate-Source Charge	Q _{gs}	-	1.2	-	nC	V _{GS} =10V, V _{DS} = 15V, ID =5.8A	
Gate-Drain Charge	Q _{gd}	-	1.8	-	nC	1	
Turn-On Delay Time	t _{D(on)}	-	3.41	-	ns		
Turn-On Rise Time	tr	-	6.18	-	ns	V _{DD} = 15V, V _{GS} = 10V,	
Turn-Off Delay Time	t _{D(off)}	-	13.92	-	ns	$R_L = 2.6\Omega, R_G = 3\Omega$	
Turn-Off Fall Time	tf	-	2.84	-	ns	7	

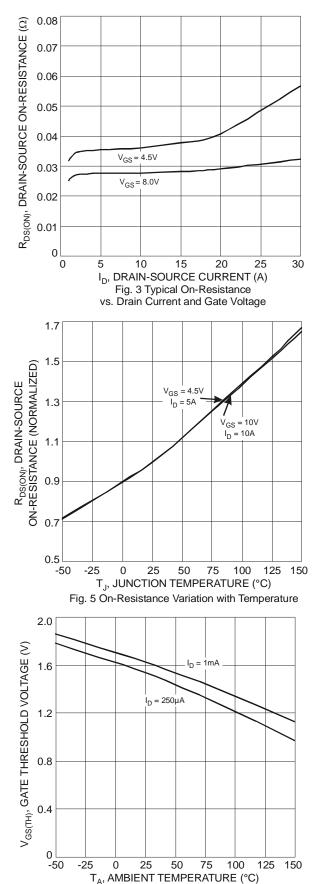
Notes:

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

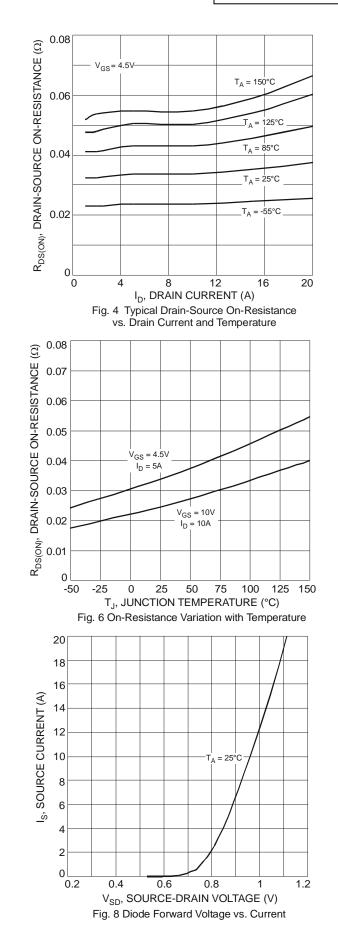








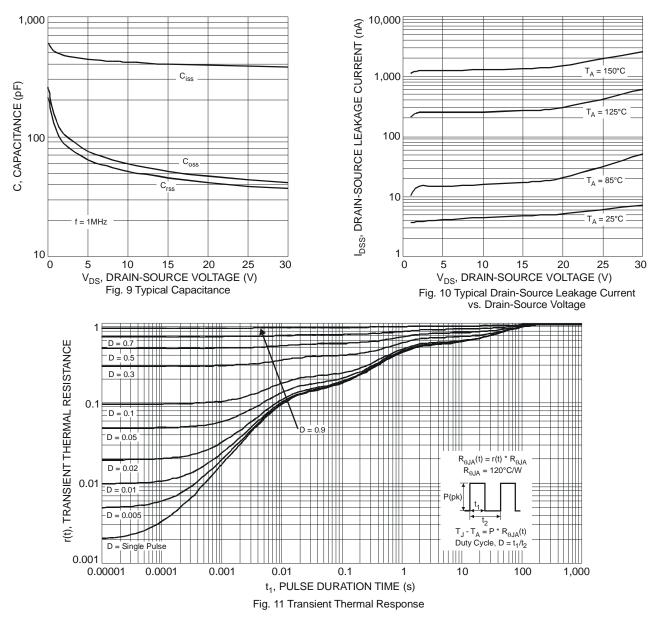




NEW PRODUCT



DMG6402LDM

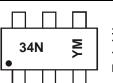


Ordering Information (Note 7)

Part Number	Case	Packaging
DMG6402LDM-7	SOT-26	3000/Tape & Reel

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



34N= Product Type Marking Code YM = Date Code Marking

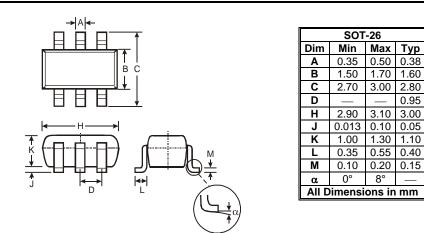
Y = Year (ex: V = 2008)

M = Month (ex: 9 = September)

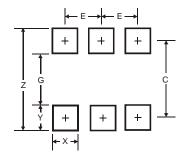
Date Code Key		<u>.</u>										
Year	2008		2009	2010		2011	2012		2013	2014	Ļ	2015
Code	V		W	Х		Y	Z		А	В		С
Month	Jan	Feb	Mar	Apr	Mav	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Y	0.80
С	2.40
E	0.95

Тур

0.38

1.60

2.80

0.95

3.00



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